

Technical documentation



Support & training



# SN65ALS1176 Differential Bus Transceiver

## 1 Features

- Meets or exceeds the requirements of TIA/EIA-422-B, TIA/EIA-485-A, and ITU recommendations V.11 and X.27
- Operates at data rates up to 35 MBaud ٠
- Operating temperature range: -25°C to 85°C
- Designed for multipoint transmission on long bus • lines in noisy environments
- Low supply-current requirement: 30 mA max
- Wide positive and negative input/output busvoltage ranges
- Thermal-shutdown protection •
- Driver positive- and negative-current limiting
- Receiver input hysteresis ٠
- Glitch-free power-up and power-down protection
- Receiver open-circuit fail-safe design
- Package options include plastic small-outline (D) package and (P) DIPs

## 2 Applications

PROFIBUS

# **3 Description**

The SN65ALS1176 differential bus transceiver is designed for bidirectional data communication on multipoint bus transmission lines. The device is designed for balanced transmission lines and meets TIA/EIA-422-B, TIA/EIA-485-A, and ITU Recommendations V.11 and X.27.

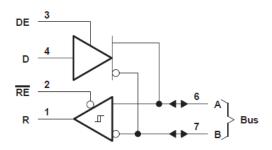
The SN65ALS1176 combines a 3-state differential line driver and a differential input line receiver, both of which operate from a single 5-V power supply. The driver and receiver have active-high and active-low enables, respectively, that can be connected together externally to function as a direction control. The driver differential outputs and the receiver differential inputs are connected internally to form a differential input/ output (I/O) bus port that is designed to offer minimum loading to the bus when the driver is disabled or  $V_{CC}$ = 0. This port features wide positive and negative common-mode voltage ranges, making the device an excellent choice for party-line applications.

The SN65ALS1176 is characterized for operation from - 25°C to 85°C.

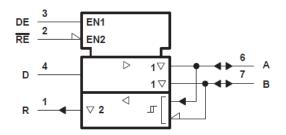
#### **Package Information**

| PART NUMBER | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)  |  |  |
|-------------|------------------------|------------------|--|--|
| SN65ALS1176 | D (SOIC)               | 4.9 mm x 3.91 mm |  |  |

(1)For all available packages, see the orderable addendum at the end of the data sheet.



Logic Diagram (Positive Logic)



A. This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### Logic Symbol





# **Table of Contents**

| 1 Features1                                | 8 Detailed Description11                                |
|--|---|
| 2 Applications1                            | 8.1 Functional Block Diagram11                          |
| 3 Description1                             | 8.2 Device Functional Modes11                           |
| 4 Revision History                         | 9 Application and Implementation12                      |
| 5 Pin Configuration and Functions          | 9.1 Application Information 12                          |
| 6 Specifications                           | 10 Device and Documentation Support13                   |
| 6.1 Absolute Maximum Ratings4              | 10.1 Documentation Support13                            |
| 6.2 Recommended Operating Conditions4      | 10.2 Receiving Notification of Documentation Updates 13 |
| 6.3 Thermal Information4                   |   |
| 6.4 Electrical Characteristics - Driver5   | 10.4 Trademarks13                                       |
| 6.5 Switching Characteristics - Driver5    | 10.5 Electrostatic Discharge Caution                    |
| 6.6 Symbol Equivalents6                    | 10.6 Glossary   |
| 6.7 Electrical Characteristics - Receiver7 |   |
| 6.8 Switching Characteristics - Receiver7  |   |
| 7 Parameter Measurement Information8       |   |

# **4 Revision History**

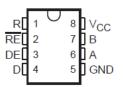
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision A (December 1999) to Revision B (January 202  | 23) Page |
|---|----------|
| Changed the document to the latest TI format                        |          |
| Deleted the P package option  |          |
| • Deleted the Package thermal impedance from the Absolute Maximum R |          |
| Added the Thermal Information table                                 | •        |
| Changes from Revision * (April 1998) to Revision A (December 1999)  | Page     |

|   |         |            |              |                 |            |      | - 3 - |  |
|---|---------|------------|--------------|-----------------|------------|------|-------|--|
| • | Changed | the docume | nt from Prod | duct Preview to | Production | data | 1     |  |



# **5** Pin Configuration and Functions



A. The D package is available taped and reeled. Add the suffix R to the device type (for example, SN65ALS1176DR).

### Figure 5-1. D Package (Top View)

#### Table 5-1. Pin Functions

| NO | Name            | Туре   | Description  |
|----|-----------------|--------|--|
| 1  | R               | 0      | Receive data output                                  |
| 2  | RE              | I      | Receiver enable, active low                          |
| 3  | DE              | I      | Driver enable, active high                           |
| 4  | D               | I      | Driver data input                                    |
| 5  | GND             | GND    | Local device ground                                  |
| 6  | A               | I/O    | Driver output or receiver input (complementary to B) |
| 7  | В               | I/O    | Driver output or receiver input (complementary to A) |
| 8  | V <sub>CC</sub> | SUPPLY | 4.75-V to 5.25-V supply                              |



# 6 Specifications

## 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |   | MIN | MAX | UNIT |
|------------------|---|-----|-----|------|
| V <sub>CC</sub>  | Supply voltage <sup>(2)</sup>                                 |     | 7   | V    |
|                  | Voltage range at any bus terminal                             | -7  | 12  | V    |
| VI               | Enable input voltage  |     | 5.5 | V    |
|                  | Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds) |     | 260 | °C   |
| T <sub>stg</sub> | Storage temperature range                                     | -65 | 150 | °C   |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

(2) All voltage values, except differential I/O bus voltage, are with respect to network ground terminal.

### **6.2 Recommended Operating Conditions**

|                                   |   |                           | MIN  | NOM | MAX  | UNIT |
|-----------------------------------|---|---------------------------|------|-----|------|------|
| V <sub>CC</sub>                   | Supply voltage                            |                           | 4.75 | 5   | 5.25 | V    |
| V <sub>I</sub> or V <sub>IC</sub> | Input voltage at any bus terminal (se     | aparately or common mode) |      |     | 12   | V    |
| VIOIVIC                           |   |                           |      |     | -7   | v    |
| V <sub>IH</sub>                   | High-level input voltage                  | D, DE, and RE             | 2    |     |      | V    |
| V <sub>IL</sub>                   | Low-level input voltage                   | D, DE, and RE             |      |     | 0.8  | V    |
| V <sub>ID</sub>                   | Differential input voltage <sup>(1)</sup> |                           |      |     | ± 12 | V    |
| 1                                 | High-level output current                 | Driver                    |      |     | -60  | mA   |
| IOH                               |   | Receiver                  |      |     | -400 | μA   |
| 1                                 |   | Driver                    |      |     | 60   | m۸   |
| IOL                               | Low-level output current                  | Receiver                  |      |     | 8    | mA   |
| T <sub>A</sub>                    | Operating free-air temperature            |                           | -25  |     | 85   | °C   |

(1) Differential input/output bus voltage is measured at the noninverting terminal A with respect to the inverting terminal B.

## 6.3 Thermal Information

|                       | THERMAL METRIC <sup>(1)</sup>                | D (SOIC) | UNIT |
|-----------------------|--|----------|------|
|                       |  | 8-Pins   |      |
| R <sub>θJA</sub>      | Junction-to-ambient thermal resistance       | 116.7    | °C/W |
| R <sub>θJC(top)</sub> | Junction-to-case thermal resistance          | 56.3     | °C/W |
| R <sub>θJB</sub>      | Junction-to-board thermal resistance         | 63.4     | °C/W |
| τι Ψ                  | Junction-to-top characterization parameter   | 8.8      | °C/W |
| Ψјв                   | Junction-to-board characterization parameter | 62.6     | °C/W |
| R <sub>θJC(bot)</sub> | Junction-to-case (bottom) thermal resistance | N/A      | °C/W |

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC package thermal metrics* application report.



## 6.4 Electrical Characteristics - Driver

over recommended ranges of supply voltage and operating free-air temperature range (unless otherwise noted)

|                                   |   | TEST CONI                         | DITIONS <sup>(1)</sup>   | MIN | TYP <sup>(2)</sup> | MAX     | UNIT |  |
|-----------------------------------|---|-----------------------------------|--|-----|--------------------|---------|------|--|
| V <sub>IK</sub>                   | Input clamp voltage   | I <sub>I</sub> = – 18 mA          |  |     |                    | -1.5    | V    |  |
| Vo                                | Output voltage  | I <sub>O</sub> = 0                | I <sub>O</sub> = 0   |     |                    | 6       | V    |  |
| V <sub>OD1</sub>                  | Differential output voltage                                       | I <sub>O</sub> = 0                |  | 1.5 |                    | 6       | V    |  |
| V <sub>OD2</sub>                  | Differential output voltage                                       | NL - 100 12 See Figure 7-1        | <sup>1</sup> / <sub>2</sub> V <sub>OD1</sub> or 2 <sup>(3)</sup> |     |                    | V       |      |  |
|                                   |   | R <sub>L</sub> = 54 Ω             | See Figure 7-1   | 2.1 | 2.5                | 5       | V    |  |
| V <sub>OD3</sub>                  | Differential output voltage                                       | V <sub>test</sub> = - 7 V to 12 V | See Figure 7-2   | 1.5 |                    | 5       | V    |  |
| Δ V <sub>OD</sub>                 | Change in magnitude of differential output voltage <sup>(4)</sup> |                                   |  |     |                    | ± 0.2   | V    |  |
| V <sub>OC</sub>                   | Common-mode output voltage  | R <sub>L</sub> = 54 Ω or 100 Ω    | See Figure 7-1   |     |                    | 3<br>–1 | V    |  |
| Δ V <sub>OC</sub>                 | Change in magnitude of common-mode output voltage <sup>(4)</sup>  |                                   |  |     |                    | ± 0.2   | V    |  |
|                                   | Output ourront  | Outpute dischlod <sup>(6)</sup>   | V <sub>0</sub> = 12 V  |     |                    | 1       |      |  |
| lo                                | Output current  | Outputs disabled <sup>(6)</sup>   | V <sub>0</sub> = - 7 V   |     |                    | -0.8    | mA   |  |
| I <sub>IH</sub>                   | High-level input current  | V <sub>I</sub> = 2.4 V            |  |     |                    | 20      | μA   |  |
| IIL                               | Low-level input current   | V <sub>I</sub> = 0.4 V            |  |     |                    | -400    | μA   |  |
|                                   |   | $V_{O} = -4 V$                    |  |     |                    | -250    |      |  |
|                                   | (1)   | V <sub>O</sub> = 0                |  |     |                    | -150    |      |  |
| I <sub>OS</sub>                   | Short-circuit output current <sup>(5)</sup>                       | V <sub>O</sub> = V <sub>CC</sub>  |  |     |                    | 250     | mA   |  |
|                                   |   | V <sub>O</sub> = 8 V              |  |     |                    | 250     |      |  |
|                                   | Current current   | Nalaad                            | Outputs enabled  |     | 23                 | 30      |      |  |
| I <sub>CC</sub> Supply current No |   | No load                           | Outputs disabled   |     | 19                 | 26      | mA   |  |

The power-off measurement in TIA/EIA-422-B applies to disabled outputs only and is not applied to combined inputs and outputs. (1)

(1) The power-on measurement in TrVEIX-22-5 applies to disabled outputs only and is not applied to combined inputs and outputs. (2) All typical values are at  $V_{CC} = 5 \text{ V}$  and  $T_A = 25^{\circ}\text{C}$ . (3) The minimum  $V_{OD2}$  with a 100- $\Omega$  load is either 1/2  $V_{OD1}$  or 2 V, whichever is greater. (4)  $\Delta |V_{OD}|$  and  $\Delta |V_{OC}|$  are the changes in magnitude of  $V_{OD}$  and  $V_{OC}$ , respectively, that occur when the input is changed from one logic state to the other.

Duration of the short circuit should not exceed one second for this test. (5)

This applies for both power on and power off; refer to TIA/EIA-485-A for exact conditions. The TIA/EIA-422-B limit does not apply for a (6) combined driver and receiver terminal

## 6.5 Switching Characteristics - Driver

over recommended ranges of supply voltage and operating free-air temperature range

|                    | PARAMETER                           |  | TEST CONDITIONS         |  | TYP <sup>(1)</sup> | MAX | UNIT |
|--------------------|-------------------------------------|--|-------------------------|--|--------------------|-----|------|
| t <sub>d(OD)</sub> | Differential output delay time      | D = 54.0                                 |                         |  |                    | 15  | ns   |
| t <sub>sk(p)</sub> | Pulse skew <sup>(2)</sup>           | $R_L = 54 \Omega$<br>See Figure 7-3      | C <sub>L</sub> = 50 pF, |  | 0                  | 2   | ns   |
| t <sub>t(OD)</sub> | Differential output transition time | Soo Higaro P o                           | e 1-5                   |  | 8                  |     | ns   |
| t <sub>PZH</sub>   | Output enable time to high level    | R <sub>L</sub> = 110 Ω<br>See Figure 7-4 | C <sub>L</sub> = 50 pF, |  |                    | 80  | ns   |
| t <sub>PZL</sub>   | Output enable time to low level     | R <sub>L</sub> = 110 Ω<br>See Figure 7-5 | C <sub>L</sub> = 50 pF, |  |                    | 30  | ns   |
| t <sub>PHZ</sub>   | Output disable time from high level | R <sub>L</sub> = 110 Ω<br>See Figure 7-4 | C <sub>L</sub> = 50 pF, |  |                    | 50  | ns   |



## 6.5 Switching Characteristics - Driver (continued)

over recommended ranges of supply voltage and operating free-air temperature range

|                  | PARAMETER                          | TEST CO                                  | NDITIONS                | MIN | TYP <sup>(1)</sup> | MAX | UNIT |
|------------------|------------------------------------|--|-------------------------|-----|--------------------|-----|------|
| t <sub>PLZ</sub> | Output disable time from low level | R <sub>L</sub> = 110 Ω<br>See Figure 7-5 | C <sub>L</sub> = 50 pF, |     |                    | 30  | ns   |

(1)

All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C Pulse skew is defined as the  $|t_{PLH}-t_{PHL}|$  of each channel of the same device. (2)

### 6.6 Symbol Equivalents

| DATA-SHEET PARAMETER | TIA/EIA-422-B                           | TIA/EIA-485-A                          |
|----------------------|---|--|
| Vo                   | V <sub>oa</sub> , V <sub>ob</sub>       | V <sub>oa</sub> , V <sub>ob</sub>      |
| V <sub>OD1</sub>     | V <sub>o</sub>                          | V <sub>o</sub>                         |
| V <sub>OD2</sub>     | V <sub>t</sub> (R <sub>L</sub> = 100 Ω) | V <sub>t</sub> (R <sub>L</sub> = 54 Ω) |
| V <sub>OD3</sub>     | None                                    | $V_t$ (test termination measurement 2) |
| Δ V <sub>OD</sub>    | $  V_t  -  V_t  $                       | $  V_t  -  V_t  $                      |
| V <sub>oc</sub>      | V <sub>os</sub>                         | V <sub>os</sub>                        |
| Δ V <sub>OC</sub>    | V <sub>os</sub> -V <sub>os</sub>        | V <sub>os</sub> -V <sub>os</sub>       |
| I <sub>OS</sub>      | I <sub>sa</sub>  ,  I <sub>sb</sub>     | None                                   |
| Ι <sub>Ο</sub>       | I <sub>xa</sub>  ,  I <sub>xb</sub>     | l <sub>ia</sub> , l <sub>ib</sub>      |



### 6.7 Electrical Characteristics - Receiver

over recommended ranges of common-mode input voltage, supply voltage, and operating free-air temperature range (unless otherwise noted)

|                  | PARAMETER   |   | ONDITIONS                   | MIN                 | TYP <sup>(1)</sup> | MAX  | UNIT |  |
|------------------|---|---|-----------------------------|---------------------|--------------------|------|------|--|
| V <sub>IT+</sub> | Positive-going input threshold voltage                    | V <sub>O</sub> = 2.7 V,                       | I <sub>O</sub> = - 0.4 mA   |                     |                    | 0.2  | V    |  |
| V <sub>IT-</sub> | Negative-going input threshold voltage                    | V <sub>O</sub> = 0.5 V,                       | I <sub>O</sub> = 8 mA       | -0.2 <sup>(2)</sup> |                    |      | V    |  |
| V <sub>hys</sub> | Hysteresis voltage (V <sub>IT+</sub> – V <sub>IT–</sub> ) |   |                             |                     | 60                 |      | mV   |  |
| V <sub>IK</sub>  | Enable-input clamp voltage                                | I <sub>I</sub> = – 18 mA                      |                             |                     |                    | -1.5 | V    |  |
| V <sub>OH</sub>  | High-level output voltage                                 | V <sub>ID</sub> = 200 mV,<br>SeeFigure 6      | I <sub>OH</sub> = - 400 μA, | 2.7                 |                    |      | V    |  |
| V <sub>OL</sub>  | Low-level output voltage                                  | V <sub>ID</sub> = - 200 mV,<br>See Figure 7-6 | I <sub>OL</sub> = 8 mA,     |                     |                    | 0.45 | V    |  |
| I <sub>OZ</sub>  | High-impedance-state output current                       | V <sub>O</sub> = 0.4 V to 2.4                 | V                           |                     |                    | ± 20 | μA   |  |
| VI               | Line input current  | Other input = 0                               | V <sub>I</sub> = 12 V       |                     |                    | 1    | m۸   |  |
| VI               |   | V <sup>(3)</sup>                              | V <sub>I</sub> = - 7 V      |                     |                    | -0.8 | - mA |  |
| I <sub>IH</sub>  | High-level-enable input current                           | V <sub>IH</sub> = 2.7 V                       |                             |                     |                    | 20   | mμA  |  |
| IIL              | Low-level-enable input current                            | V <sub>IL</sub> = 0.4 V                       |                             |                     |                    | -100 | μA   |  |
| r <sub>l</sub>   | Input resistance  |   |                             | 12                  | 20                 |      | kΩ   |  |
| I <sub>OS</sub>  | Short-circuit output current                              | V <sub>ID</sub> = 200 mV,                     | V <sub>O</sub> = 0          | -15                 |                    | -85  | mA   |  |
| 1                | Supply current  | No load                                       | Outputs enabled             |                     | 23                 | 30   | m۸   |  |
| I <sub>CC</sub>  | Supply current  | INU IUau                                      | Outputs disabled            |                     | 19                 | 26   | – mA |  |

(1) All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

(2) The algebraic convention, in which the less positive (more negative) limit is designated minimum, is used in this data sheet for common-mode input voltage and threshold voltage levels only.

(3) This applies for both power on and power off. Refer to TIA/EIA-485-A for exact conditions.

## 6.8 Switching Characteristics - Receiver

over recommended ranges of supply voltage and operating free-air temperature range

| PARAMETER          |                                     | TEST CONE                           | MIN                     | TYP <sup>(1)</sup> | MAX | UNIT |    |
|--------------------|-------------------------------------|-------------------------------------|-------------------------|--------------------|-----|------|----|
| t <sub>pd</sub>    | Propagation time                    | V <sub>ID</sub> = – 1.5 V to 1.5 V, | 0 - 15 - 5              |                    |     | 25   | ns |
| t <sub>sk(p)</sub> | Pulse skew <sup>(2)</sup>           | See Figure 7-7                      | C <sub>L</sub> = 15 pF, |                    | 0   | 2    | ns |
| t <sub>PZH</sub>   | Output enable time to high level    | C <sub>L</sub> = 15 pF,             |                         |                    | 11  | 18   | ns |
| t <sub>PZL</sub>   | Output enable time to low level     |                                     | See Figure 7-8          |                    | 11  | 18   | ns |
| t <sub>PHZ</sub>   | Output disable time from high level |                                     |                         |                    |     | 50   | ns |
| t <sub>PLZ</sub>   | Output disable time from low level  |                                     |                         |                    |     | 30   | ns |

(1) All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

(2) Pulse skew is defined as the  $|t_{PLH} - t_{PHL}|$  of each channel of the same device.



## **7 Parameter Measurement Information**

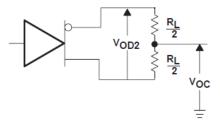


Figure 7-1. Driver  $V_{\text{OD2}}$  and  $V_{\text{OC}}$  Test Circuit

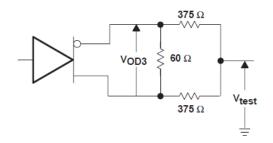
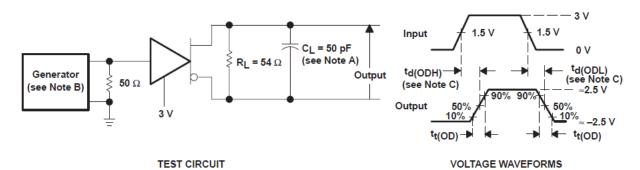
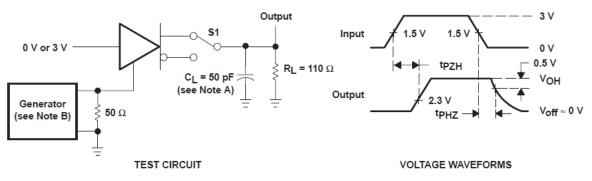


Figure 7-2. Driver V<sub>OD3</sub> Test Circuit



- A. C<sub>L</sub> includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>0</sub> = 50  $\Omega$ .
- C.  $t_{d(OD)} = t_{d(ODH)}$  or  $t_{d(ODL)}$ .

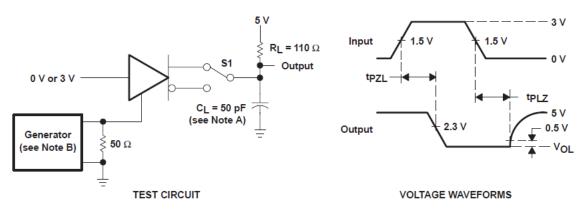




A.  $C_L$  includes probe and jig capacitance.



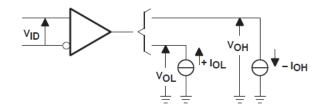
B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>0</sub> = 50  $\Omega$ .

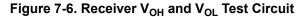


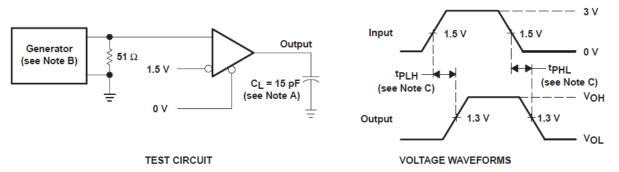
### Figure 7-4. Driver Enable and Disable Times

- A. C<sub>L</sub> includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>O</sub> = 50  $\Omega$ .

#### Figure 7-5. Driver Enable and Disable Times



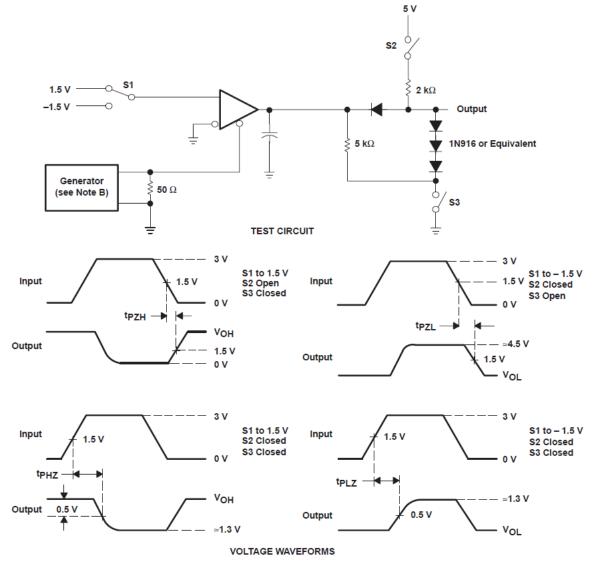




- A. C<sub>L</sub> includes probe and jig capacitance.
- B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>O</sub> = 50  $\Omega$ .
- C.  $t_{pd} = t_{PLH} \text{ or } t_{PHL}$ .

#### Figure 7-7. Receiver Propagation-Delay Times





A.  $C_L$  includes probe and jig capacitance.

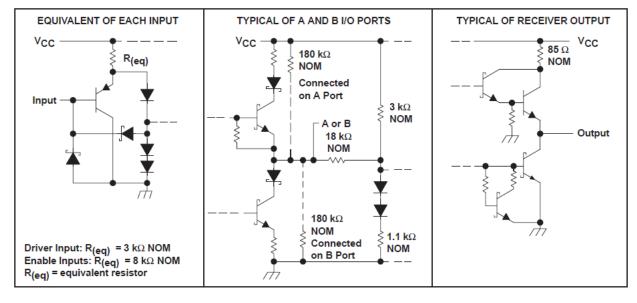
B. The input pulse is supplied by a generator having the following characteristics: PRR  $\leq$  1 MHz, 50% duty cycle, t<sub>r</sub>  $\leq$  6 ns, t<sub>f</sub>  $\leq$  6 ns, Z<sub>O</sub> = 50  $\Omega$ .

#### Figure 7-8. Receiver Output Enable and Disable Times



# 8 Detailed Description

## 8.1 Functional Block Diagram





## 8.2 Device Functional Modes

#### **Function Tables**

#### Table 8-1. Driver<sup>(1)</sup>

| INPUT | ENABLE | OUTPUTS |   |  |  |  |
|-------|--------|---------|---|--|--|--|
| D     | DE     | A       | В |  |  |  |
| Н     | Н      | Н       | L |  |  |  |
| L     | Н      | L       | н |  |  |  |
| X     | L      | Z       | Z |  |  |  |

(1) H = high level, L = low level, X = irrelevant, ? = indeterminate, Z = high impedance (off).

#### Table 8-2. Receiver<sup>(1)</sup>

| DIFFERENTIAL INPUTS<br>A-B       | ENABLE<br>RE | OUTPUT<br>R |  |  |  |  |  |  |  |
|----------------------------------|--------------|-------------|--|--|--|--|--|--|--|
| V <sub>ID</sub> ≥ 0.2 V          | L            | Н           |  |  |  |  |  |  |  |
| -0.2 V < V <sub>ID</sub> < 0.2 V | L            | ?           |  |  |  |  |  |  |  |
| $V_{\rm ID} \leq -0.2  \rm V$    | L            | L           |  |  |  |  |  |  |  |
| X                                | н            | Z           |  |  |  |  |  |  |  |
| Inputs open                      | L            | н           |  |  |  |  |  |  |  |

(1) H = high level, L = low level, X = irrelevant, ? = indeterminate, Z = high impedance (off).



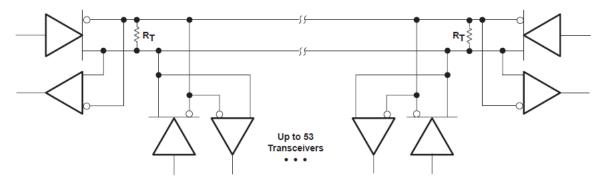
# **9** Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 9.1 Application Information

#### 9.1.1 Typical Application



A. The line should terminate at both ends in its characteristic impedance (R<sub>T</sub> = Z<sub>0</sub>). Stub lengths off the main line should be kept as short as possible.

Figure 9-1. Typical Application Circuit



## **10 Device and Documentation Support**

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

#### **10.1 Documentation Support**

#### 10.1.1 Related Documentation

#### **10.2 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **10.3 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 10.4 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments.

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#### **10.5 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

### 10.6 Glossary

TI Glossary This glossary lists and explains terms, acronyms, and definitions.

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|---------|
| SN65ALS1176D     | NRND          | SOIC         | D                  | 8    | 75             | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -25 to 85    | 6A1176                  |         |
| SN65ALS1176DR    | ACTIVE        | SOIC         | D                  | 8    | 2500           | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -25 to 85    | 6A1176                  | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

w

(mm)

12.0

Pin1 Quadrant

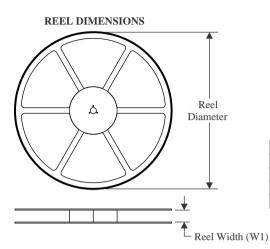
Q1



Texas

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## TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |   |      |                          |                          |            |            |            |            |
|-----------------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|
| Device                      | Package<br>Type | Package<br>Drawing |   |      | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) |
| SN65ALS1176DR               | SOIC            | D                  | 8 | 2500 | 330.0                    | 12.4                     | 6.4        | 5.2        | 2.1        | 8.0        |



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# PACKAGE MATERIALS INFORMATION

1-Sep-2023



\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN65ALS1176DR | SOIC         | D               | 8    | 2500 | 356.0       | 356.0      | 35.0        |

# TEXAS INSTRUMENTS

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# TUBE



# - B - Alignment groove width

\*All dimensions are nominal

| Device       | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | Τ (μm) | B (mm) |
|--------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| SN65ALS1176D | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |

# D0008A



# **PACKAGE OUTLINE**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



#### NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.

- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.
- 5. Reference JEDEC registration MS-012, variation AA.



# D0008A

# **EXAMPLE BOARD LAYOUT**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# D0008A

# **EXAMPLE STENCIL DESIGN**

# SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

9. Board assembly site may have different recommendations for stencil design.



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